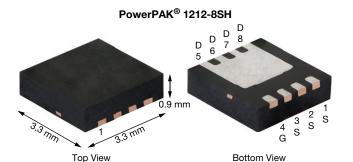
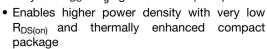
# N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00325				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0046				
Q <sub>g</sub> typ. (nC)	7.6				
I <sub>D</sub> (A)	67.4				
Configuration	Single				

#### **FEATURES**

- TrenchFET® Gen V power MOSFET
- Very low R<sub>DS</sub> x Q<sub>q</sub> figure-of-merit (FOM)

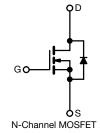




- 100 % R<sub>q</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

#### APPLICATIONS

- DC/DC converter
- POL
- · Synchronous rectification
- · Battery management
- · Power and load switch



ORDERING INFORMATION	
Package	PowerPAK 1212-8SH
Lead (Pb)-free and halogen-free	SiSH536DN-T1-GE3
ABSOLUTE MAXIMUM RATINGS (TA =	25 °C unless otherwise noted)

<b>ABSOLUTE MAXIMUM RATING</b>	<b>S</b> (T <sub>A</sub> = 25 °C, u	ınless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	30	V	
Gate-source voltage		V <sub>GS</sub>	+16 / -12	v	
	T <sub>C</sub> = 25 °C		67.4		
Continuous drain augrent (T. 150 °C)	T <sub>C</sub> = 70 °C	1 .	54		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	24.7 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	19.7 <sup>b, c</sup>	^	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	200	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		24.1		
	T <sub>A</sub> = 25 °C	l <sub>S</sub>	3.2 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	20		
Single pulse avalanche energy  L = 0.1 mH		E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		26.5		
Maximum power dissipation	T <sub>C</sub> = 70 °C	1 5	17	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.57 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	†	2.3 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	%0	
Soldering recommendations (peak temperature) <sup>c</sup>			260	°C	

THERMAL RESISTANCE RATING	àS				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	28	35	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	3.8	4.7	C/VV

a. Package limited
b. Surface mounted on 1" x 1" FR4 board

S20-0969-Rev. A, 21-Dec-2020

 $T_C = 25$  °C

t = 10 s
See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
Maximum under steady state conditions is 81 °C/W

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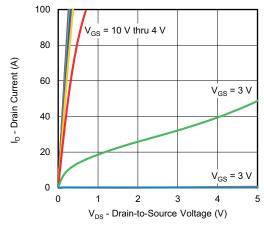
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	1			•	•	ı
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	30	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	23	-	14/00
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-4.2	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	-	2.2	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +16 / -12 \text{ V}$	-	-	100	nA
	1 .	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	-	-	15	μA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	Α
During and a second sec		$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	0.0027	0.00325	Ω
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.0038	0.0046	
Forward transconductance a	g <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_{D} = 10 \text{ A}$	-	53	-	S
Dynamic <sup>b</sup>	<u> </u>			1	1	L
Input capacitance	C <sub>iss</sub>		-	1150	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	392	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	27	-	
Total gata abayes	Q <sub>g</sub> -	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	16.6	25	nC
Total gate charge			-	7.6	11.5	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	3.7	-	
Gate-drain charge	Q <sub>gd</sub>		-	1.4	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$	-	10.7	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.3	0.9	1.6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	9	18	
Rise time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$ , $I_D$ $\cong$ 10 A,	-	5	10	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	18	36	
Fall time	t <sub>f</sub>		-	5	10	ns
Turn-on delay time	t <sub>d(on)</sub>		-	12	24	113
Rise time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$ , $I_D$ $\cong$ 10 A,	-	9	18	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	18	36	
Fall time	t <sub>f</sub>		-	8	16	
Drain-Source Body Diode Characteristi	cs					1
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	24.1	Α
Pulse diode forward current	I <sub>SM</sub>		-	-	200	, ,
Body diode voltage	V <sub>SD</sub>	$I_{S} = 5 A, V_{GS} = 0 V$	-	0.76	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	21	42	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	10	20	nC
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25  ^{\circ}C$	-	10	-	ns
Reverse recovery rise time	t <sub>b</sub>		-	11	-	113

#### Notes

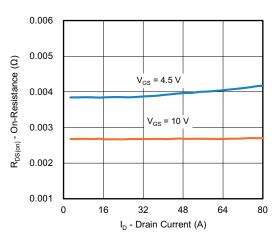
- a. Pulse test; pulse width  $\leq 300~\mu s,\,duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

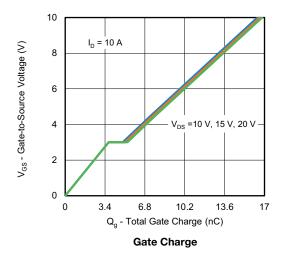


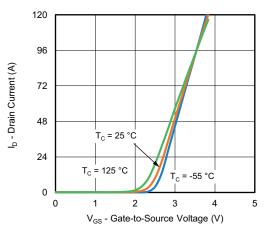


#### **Output Characteristics**

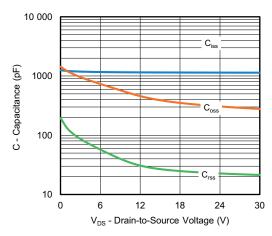


On-Resistance vs. Drain Current and Gate Voltage

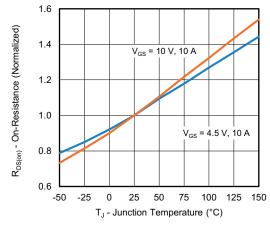




**Transfer Characteristics** 

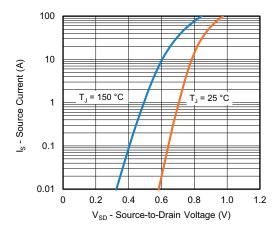


Capacitance

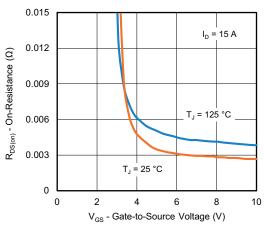


On-Resistance vs. Junction Temperature

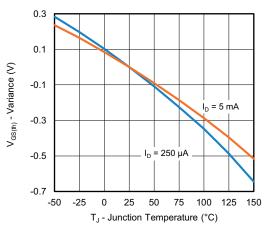




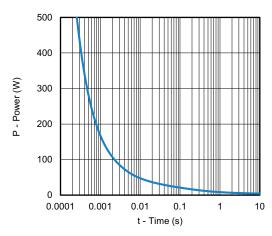
Source-Drain Diode Forward Voltage



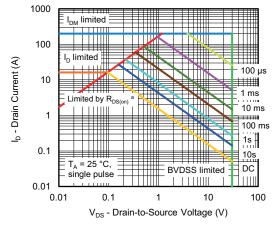
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

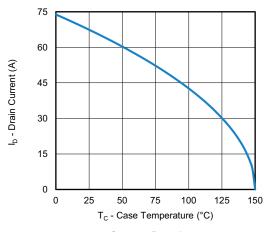


Safe Operating Area, Junction-to-Ambient

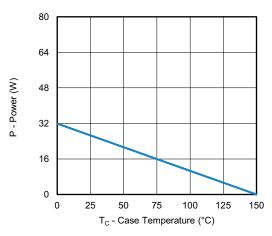
#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

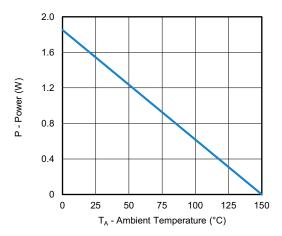




#### Current Derating a





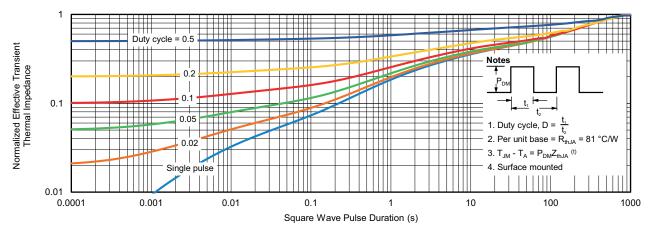


Power, Junction-to-Ambient

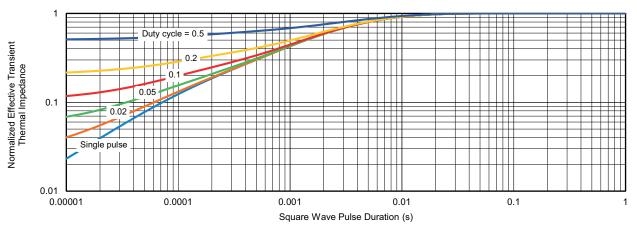
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



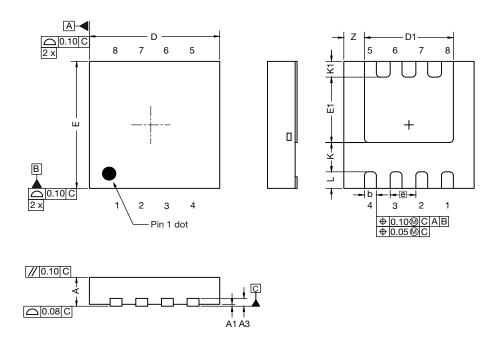
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?66834">www.vishay.com/ppg?66834</a>.



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# Case Outline for PowerPAK® 1212-SWLH and PowerPAK® 1212-8SH



DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.82	0.90	0.98	0.032	0.035	0.038	
A1	0.00	-	0.05	0.000	-	0.002	
A3		0.20 ref.			0.008 ref.		
b	0.25	0.30	0.35	0.010	0.012	0.014	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.15	2.25	2.35	0.085	0.089	0.093	
Е	3.20	3.30	3.40	0.126	0.130	0.134	
E1	1.60	1.70	1.80	0.063	0.067	0.071	
е		0.65 bsc.			0.026 bsc.		
K		0.76 ref.		0.030 ref.			
K1	0.41 ref.		0.016 ref.				
L	0.33	0.43	0.53	0.013	0.017	0.021	
Z	0.525 ref.		0.021 ref.				

DWG: 6062



# RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP NTMC083NP10M5L NVMFS2D3P04M8LT1G BXP7N65D
BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR
DMNH15H110SK3-13 SLF10N65ABV2 BSO203SP BSO211P